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# SH7211 Group

## Sample Settings at CPG Operation Frequency Change

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### Introduction

This application note presents sample settings for changing the operating frequency of the clock pulse generator (CPG) of the SH7211.

### Target Devices

SH7211

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## 1. Preface

### 1.1 Specifications

- The clock pulse generator (CPG) settings are changed to change the operating frequency.
- The watchdog timer is used to provide the necessary PLL settling time when changing the multiplication ratio of the PLL circuit.

### 1.2 Functions Used

- Clock pulse generator (CPG)
- Watchdog timer (WDT)

### 1.3 Application Conditions

- MCU: SH7211
- Operating frequencies: Internal clock = 160 MHz  
Bus clock = 40 MHz  
Peripheral clock = 40 MHz  
MTU2S clock = 80 MHz  
AD clock = 40 MHz
- C compiler: Renesas Technology SuperH RISC Engine Family C/C++ Compiler Package, Ver. 9.01, Release 01
- Compile options: HEW default settings (-cpu=sh2a -debug -gbr=auto -chgincpath -global\_volatile=0 -opt\_range=all -infinite\_loop=0 -struct\_alloc=1 -nologo)

### 1.4 Related Application Notes

The reference program code provided in this application note has been confirmed to work under the setting conditions described in the SH7211 application note “Example of Initialization.”

## 2. The Application Example

In this application example, the watchdog timer (WDT) is used to count the clock oscillation settling time when the operating frequency is changed.

### 2.1 Operational Overview of the Functions Used

When the multiplication ratio of the PLL circuit of the clock pulse generator (CPG) is changed, it is necessary to provide time for the PLL to settle following the change. The on-chip WDT is used to ensure the proper PLL settling time.

When the timer enable (TME) bit is cleared to 0 and the CPG's frequency control register (FRQCR) is overwritten to change the PLL multiplication ratio, CPU internal operation stops temporarily and the WDT starts counting. When the WDT overflows, the CPG starts to supply the clock and CPU operation resumed.

Tables 1 and 2 provide an overview of the CPG and WDT. Figures 1 and 2 show a visual overview of the CPG and WDT.

**Table 1 Overview of CPG**

Item	Description
Clock operating modes	4
Clocks generated	Internal clock (I $\phi$ ) : Used by CPU Peripheral clock (P $\phi$ ) : Used by on-chip peripheral modules Bus clock (B $\phi$ ) : Used by external bus interface
Frequency change function	The frequencies of the internal clock and peripheral clock can be changed independently by means of the CPG's internal PLL circuit and peripheral circuits.
Control of low-power modes	The clock can be stopped in sleep mode, software standby mode, and deep standby mode, and the operation of specific modules can be stopped by using the module standby function.

**Table 2 Overview of WDT**

Item	Description
Channels	1
Counter	8-bit counter (up-counter only)
Timer modes	Watchdog timer mode, interval timer mode
Pin functions	WDTOVF: Counter overflow signal output in watchdog timer mode
Clock sources	P $\phi$ , P $\phi$ /64, P $\phi$ /128, P $\phi$ /256, P $\phi$ /512, P $\phi$ /1024, P $\phi$ /4096, P $\phi$ /16384 P $\phi$ : On-chip peripheral clock
Activation methods	Watchdog timer/interval timer: Activated by software At frequency change: Activated by software At cancelation of software standby mode: Activated by interrupt detection

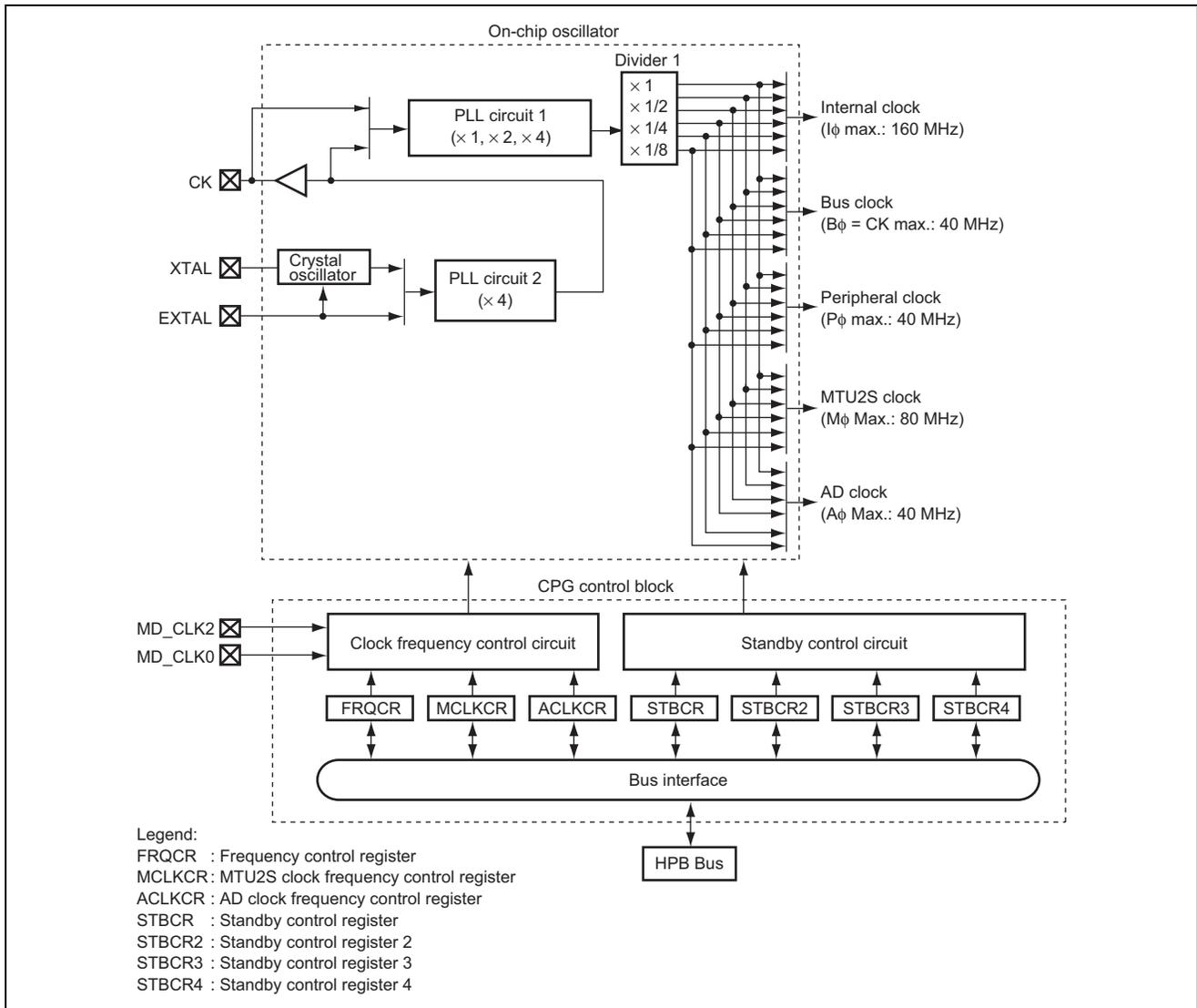


Figure 1 Overview of CPG

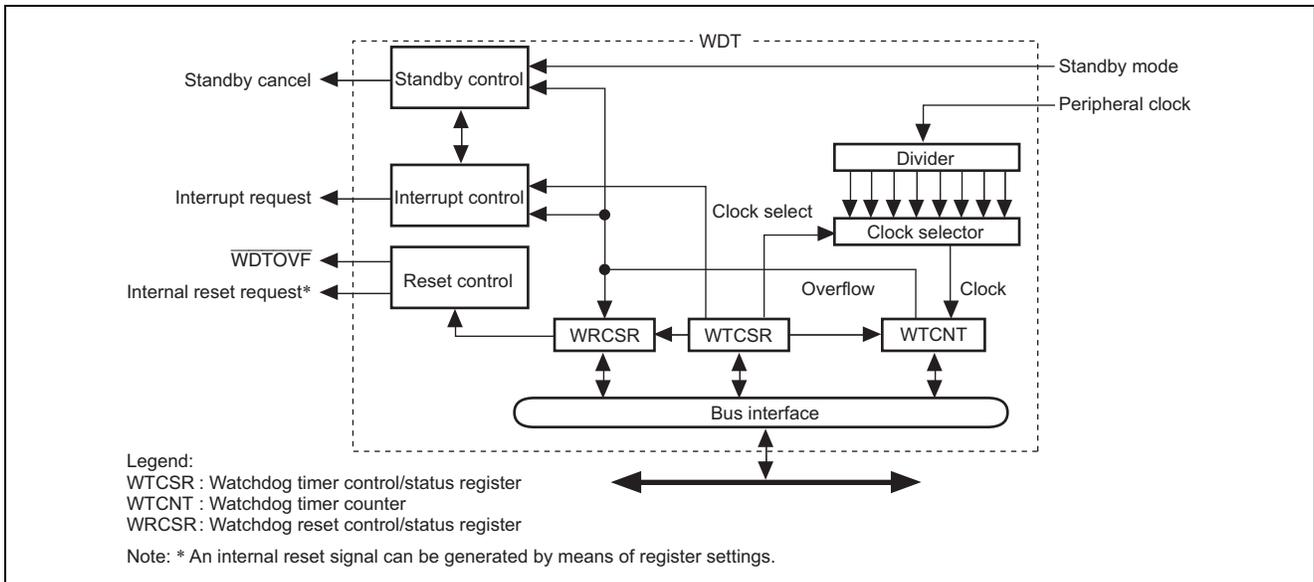


Figure 2 Overview of WDT

## 2.2 Setup Procedure for the Functions Used

Figure 3 shows an example settings sequence for changing the operating frequency.

For details on the register settings, see the SH7211 Group Hardware Manual.

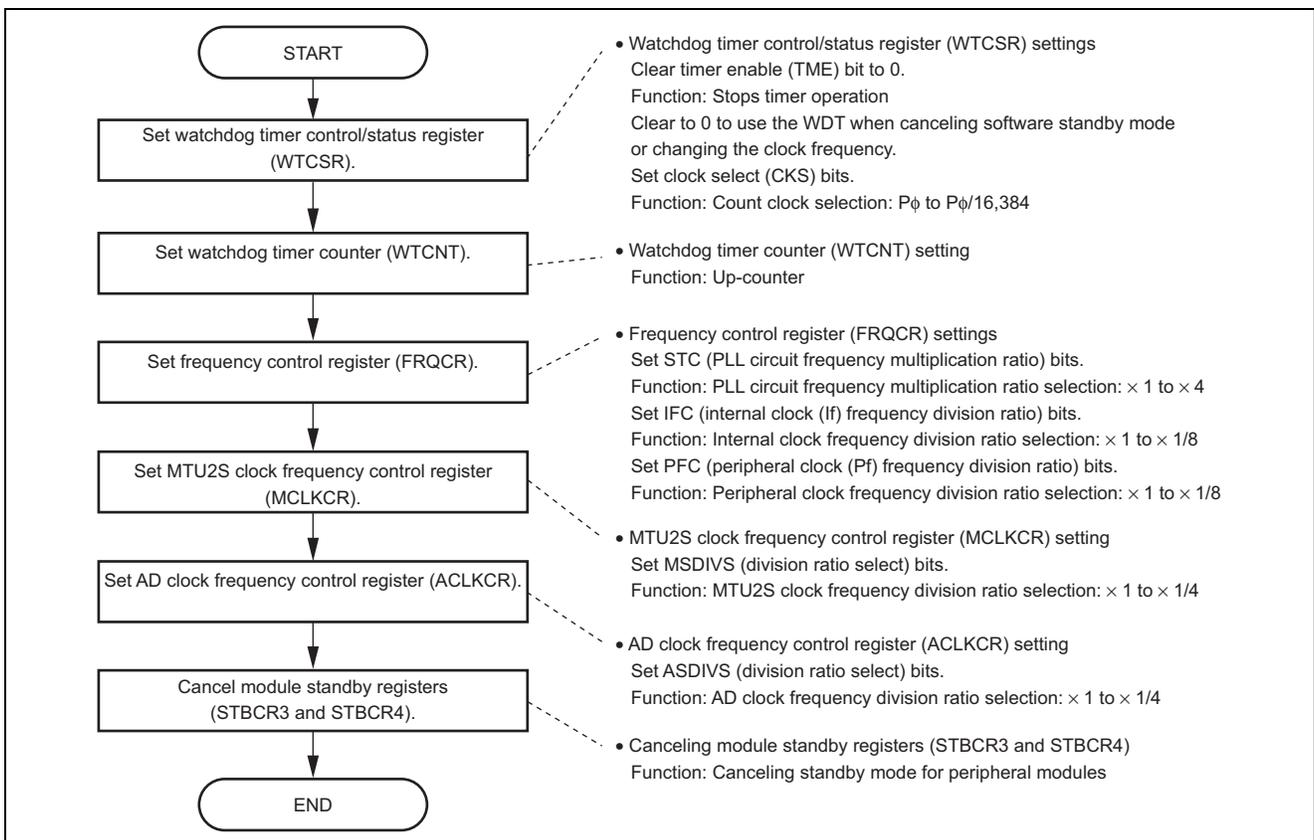


Figure 3 Example Settings Sequence for Changing Operating Frequency

### 2.3 Operation of Reference Program

Table 3 lists the register settings for changing the operating frequency, and table 4 lists the operating frequencies used in the reference program.

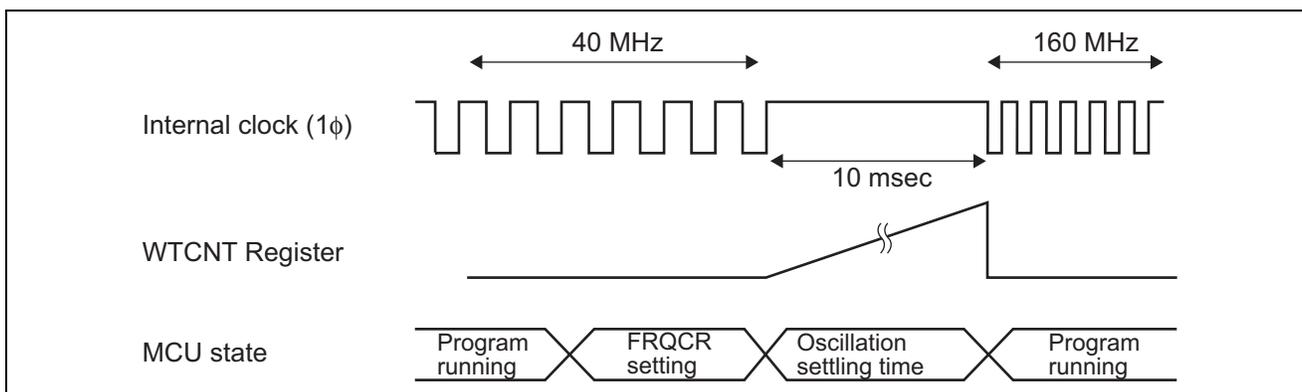
The peripheral functions are in module standby mode after a reset. The reference program makes CPG settings and then cancels module standby mode.

**Table 3 Register Settings for Changing Operating Frequency**

Register Name	Address	Setting Value	Function
Watchdog timer control/status register (WTCSR)	H'FFFE 0000	H'A51E	TME = 0: Timer disabled CKS[2:0] = B'110: 1/4096 × Pφ Overflow period: 26.21 ms (when Pφ = 40 MHz)
Watchdog timer counter (WTCNT)	H'FFFE 0002	H'5A9E	Set count value so oscillation settling time is 10 msec. or more. (H'100 – H'9E) × (1/4,096 × Pφ) = 10.04 ms
Frequency control register (FRQCR)	H'FFFE 0010	H'1303	STC[1:0] = B'11 PLL circuit 1 frequency multiplication ratio = ×4 IFC[2:0] = B'000 Internal clock frequency division ratio = ×1 PFC[2:0] = B'011 Peripheral clock frequency division ratio = ×1/4
MTU2S clock frequency control register (MCLKCR)	H'FFFE0410	H'41	MSDIVS[1:0] = B'01 Division ratio select = ×1/2
AD clock frequency control register (CLKCR)	H'FFFE0414	H'43	ASDIVS[1:0] = B'11 Division ratio select = ×1/4

**Table 4 Operating Frequencies Used in Reference Program**

	FRQCR Setting Value	Clock Ratio (I: B: P)	Operating Frequencies (I: B: P)
Operating frequency with initial settings	H'1003	4: 4: 1	40 MHz: 40 MHz: 10 MHz
Operating frequency after change	H'1303	16: 4: 4	160 MHz: 40 MHz: 40 MHz



**Figure 4 Conceptual View of Reference Program Operation Timing**

### 3. Sample Program

```

1  /*"FILE COMMENT"*****
2  *
3  *      System Name : SH7211 Sample Program
4  *      File Name   : cpg.c
5  *      Version     : 1.01.00
6  *      Contents    : CPG Setting Processing
7  *      Model       : M3A-HS11
8  *      CPU         : SH7211
9  *      Compiler    : SHC9.1.1.0
10 *      OS          : none
11 *
12 *      note        :
13 *                  : <Notes>
14 *                  : This sample program is provided for reference
15 *                  : purposes; its operation is not guaranteed.
16 *                  : This sample program may be used for reference
17 *                  : purposes when developing user applications.
18 *
19 *                  : <Caution>
20 *                  : This sample programs are all reference,
21 *                  : and no one to guarantee the operation.
22 *                  : Please use this sample program for the technical
23 *                  : reference when customers develop softwares.
24 *
25 *      Copyright (C) 2006(2007) Renesas Technology Corp. All Rights Reserved
26 *      AND Renesas Solutions Corp. All Rights Reserved
27 *
28 *      history     : 2006.02.23 ver.1.00.00
29 *                  : 2007.04.03 ver.1.01.00
30 *"FILE COMMENT END"*****/
31 #include "iodefine.h"
32
33 /* ==== Prototype declaration ==== */
34 void io_set_cpg(void);
35

```

**Figure 5 Sample Program Listing: cpg.c (1)**

```

36  /*"FUNC COMMENT"*****
37  * ID          :
38  * Module outline : CPG setting
39  *-----
40  * Include     : #include "iodefine.h"
41  *-----
42  * Declaration  : void io_set_cpg(void)
43  *-----
44  * Function     : The clock pulse generator (CPG) setting are as follows.
45  *             : Clock pulse generator (CPG) is set as follows.
46  *             :
47  *             : I Clock = 160MHz, B Clock = 40MHz, P Clock = 40MHz
48  *             : MTU2S = 80MHz, A/D = 40MHz
49  *-----
50  * Argument    : None
51  *-----
52  * Return value : None
53  *-----
54  * Note       : This function is a setting example using an input clock frequency of 10 MHz.
55  *           : This function is the setting example when the input clock 10MHz.
56  *"FUNC COMMENT END"*****/
57  void io_set_cpg(void)
58  {
59      /* ==== CPG Set ==== */
60      WDT.WRITE.WTCSR = 0xa51e;          /* WDT stop, WDT count clock setting */
61                                      /* 1/4096 xP-clock 40MHz;26.2ms */
62      WDT.WRITE.WTCNT = 0x5a9e;        /* Counter initial setting 10mS */
63      CPG.FRQCR.WORD = 0x1303;         /* PLL1(x4),PLL2(x4),I:B:P=16:4:4
64                                      * Clockin = 10MHz, CKIO = 40MHz
65                                      * I Clock = 160MHz, B Clock = 40MHz,
66                                      * P Clock = 40MHz
67                                      */
68      CPG.MCLKCR.BYTE = 0x41;          /* MTU2S =80MHz */
69      CPG.ACLKCR.BYTE = 0x43;         /* AD = 40MHz */
70
71      /* ==== Enable module clock ==== */
72      STB.CR3.BYTE = 0x00;             /* Module Standby Clear
73                                      * MTU2S,MTU2,POE2,IIC3,ADC,DAC */
74
75      STB.CR4.BYTE = 0x00;             /* Module Standby Clear
76                                      * SCIF0-3,CMT,WAVE */
77  }
78
79  /* End of File */

```

**Figure 6 Sample Program Listing: cpg.c (2)**

#### 4. Reference Documents

- Software Manual  
SH-2A, SH2A-FPU Software Manual, Rev. 3.00  
(The latest version can be downloaded from the Renesas Technology Web site.)
- Hardware Manual  
SH7211 Group Hardware Manual, Rev. 2.00  
(The latest version can be downloaded from the Renesas Technology Web site.)

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#### Revision Record

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		Page	Summary
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